Hyperfast Diode 75 A, 600 V

FFH75H60S

Description

The FFH75H60S is a hyperfast diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Features

- Hyperfast Recovery $t_{rr} = 75 \text{ ns} (@ I_F = 75 \text{ A})$
- Max Forward Voltage, $V_F = 1.8 V (@ T_C = 25^{\circ}C)$
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- This Device is Pb-Free and is RoHS Compliant

Applications

- General Purpose
- SMPS, Solar Inverter, UPC
- Power Switching Circuits
- Solar Inverter, UPC

ABSOLUTE MAXIMUM RATINGS (T_C = 25° C unless otherwise noted)

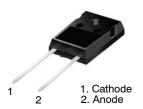
Parameter	Symbol	Ratings	Unit	
Peak Repetitive Reverse Voltage	V _{RRM}	600	V	
Working Peak Reverse Voltage	V _{RWM}	600	V	
DC Blocking Voltage	V _R	600	V	
Average Rectified Forward Current $(T_C = 105^{\circ}C)$	I _{F(AV)}	75	A	
Non-repetitive Peak Surge Current 60 Hz Single Half-Sine Wave	I _{FSM}	750	A	
Operating Junction and Storage Temperature	T _{J,} T _{STG}	-65 to 175	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

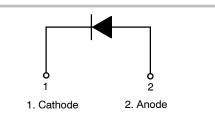


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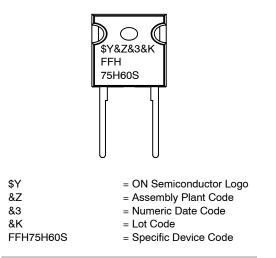
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MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FFH75H60S

THERMAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Parameter	Symbol	Max	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.4	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FFH75H60S	FFH75H60S	TO-247-2LD	Tube	N/A	N/A	30

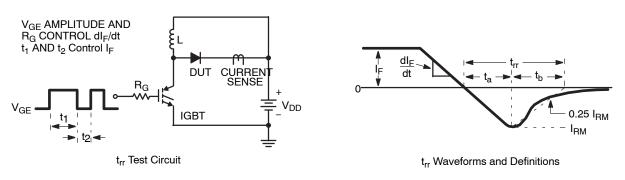
ELECTRICAL Characteristics ($T_C = 25^{\circ}C$ unless otherwise specified)

Parameter	Conditions	Min	Тур	Max	Unit	
V _F (Note 1)	I _F = 75 A	$T_C = 25^{\circ}C$	-	1.8	2.2	V
	I _F = 75 A	T _C = 125°C	-	1.6	2.0	V
I _R (Note 1)	V _R = 600 V	$T_C = 25^{\circ}C$	-	-	100	μA
	V _R = 600 V	T _C = 125°C	-	-	1.0	mA
t _{rr}	I_F = 75 A, dI_F/dt = 200 A/µs, V_R = 390 V	$T_C = 25^{\circ}C$	-	40	75	ns
		T _C = 125°C	-	85	-	ns
t _a	I_F = 75 A, dI_F/dt = 200 A/µs, V_R = 390 V	$T_C = 25^{\circ}C$	-	23	-	ns
t _b		$T_C = 25^{\circ}C$	-	17	-	ns
Q _{rr}		$T_C = 25^{\circ}C$		80	-	nC
W _{AVL}	Avalanche Energy (L = 40 mH)		20	-	-	mJ

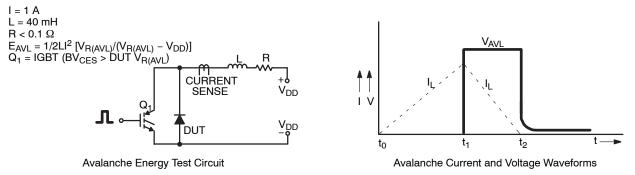
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse: Test Pulse Width = 300 μ s, Duty Cycle = 2%

TEST CIRCUITS AND WAVEFORMS



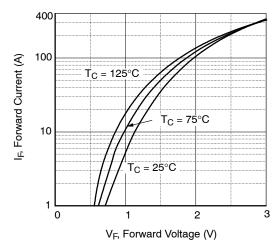


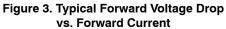




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TYPICAL PERFORMANCE CHARACTERISTICS





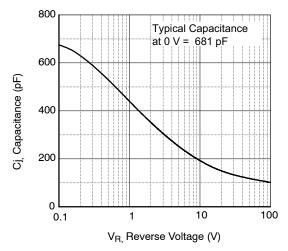
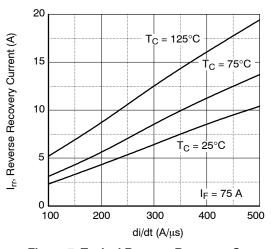
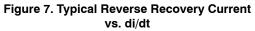


Figure 5. Typical Junction Capacitance





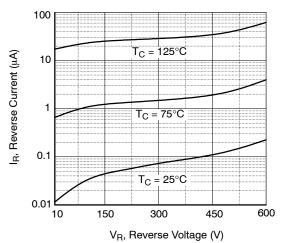


Figure 4. Typical Reverse Current vs. Reverse Voltage

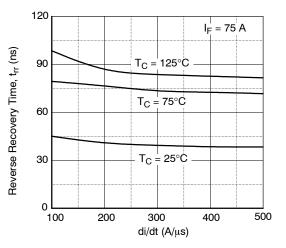
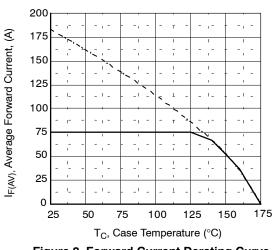


Figure 6. Typical Reverse Recovery Time vs. di/dt





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TYPICAL PERFORMANCE CHARACTERISTICS (continued)

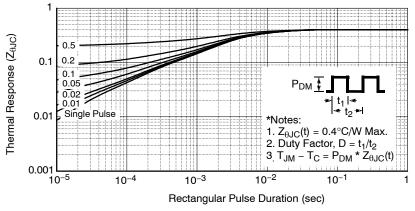


Figure 9. Transient Thermal Response Curve

1

MILLIMETERS

NOM

4.70

2.40

1.50

1.26

1.65

0.61

20.57

16.57

0.93

15.62

~

5.08

11.12

16.00

3.81

3.58

6.73

5.46

5.46

MAX

4.82

2.66

1.70

1.35

1.77

0.71

20.82

16.77

1.35

15.87

~

5.20

~

16.25

3.93

3.65

6.85

5.58

5.58

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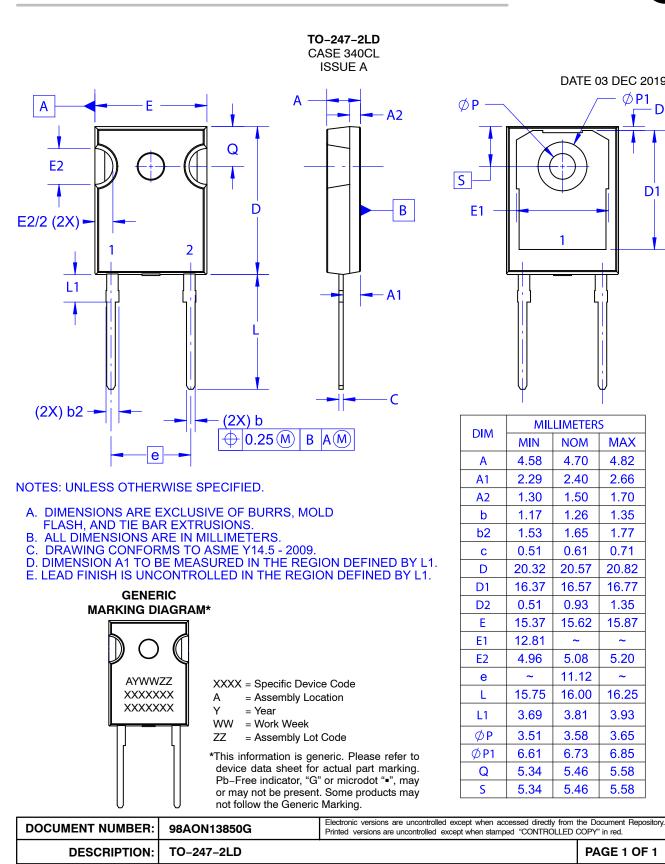
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